Claims

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What is claimed is:

- 1. A method for making a diamond tool comprising the steps of:
- a) providing a mold having a diamond interface surface configuration which inversely corresponds to a desired shape for a working surface of the tool;
- b) coating said diamond interface surface with diamond using a chemical vapor deposition (CVD) technique to form a diamond layer; and
- c) separating the mold from the diamond layer; such that the resultant diamond layer has a working surface which inversely corresponds to the diamond interface surface configuration of the mold.
- 2. The method of claim 1, wherein said mold comprises a metal material.
- 3. The method of claim 2, wherein said metal material is a member selected from the group consisting of tungsten, molybdenum, tantalum, zirconium, vanadium, chromium, carbides thereof, copper, and mixtures thereof.

- 4. The method of claim 1, wherein said diamond interface surface is smooth.
- 5. The method of claim 1, wherein said diamond interface surface is rough.
 - 6. The method of claim 1, wherein said diamond interface surface has a concave configuration.
- 7. The method of claim 1, wherein said diamond interface surface has a convex configuration.

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- 8. The method of claim 1, wherein said diamond interface surface configuration inversely corresponds to the shape of a drawing dye.
- 9. The method of claim 8, wherein said drawing dye has a channel with a non-spherical shape.
- 20 10. The method of claim 1, wherein said diamond interface surface configuration inversely corresponds to the shape of a chemical mechanical polishing (CMP) pad dresser.
 - 11. The method of claim 1, wherein said diamond interface

surface configuration inversely corresponds to the shape of a pipe.

12. The method of claim 1, wherein said diamond interface surface configuration inversely corresponds to the shape of a diaphragm.

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- 13. The method of claim 1, wherein said diamond interface surface configuration inversely corresponds to the shape of a cutting element.
- 14. The method of claim 13, wherein said cutting element contains chip breakers.
- 15. The method of claim 1, wherein said diamond layer has a thickness of from about 20 microns to about 200 microns.
 - 16. The method of claim 1, further comprising the step of increasing the thickness of said diamond layer to a desired thickness, using a non-chemical vapor deposition process.
 - 17. The method of claim 1, wherein said CVD technique is a member selected from the group consisting of: hot filament, microwave plasma, oxyacetylene flame, and arc jet techniques.

- 18. The method of claim 17, wherein said CVD technique utilizes a combination of methane and hydrogen gasses.
- 19. The method of claim 1, wherein step c) is accomplished by chemically removing the mold from the diamond layer.

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- 20. The method of claim 1, further comprising the step of attaching said diamond layer to a non-diamond material for incorporation into a tool.
- 21. A diamond tool formed by the process comprising the steps of:
- a) providing a mold having a diamond interface surface configuration which inversely corresponds to a desired shape for a working surface of the tool;
- b) coating said diamond interface surface with diamond using a chemical vapor deposition (CVD) technique to form a diamond layer; and
- c) separating the mold from the diamond layer; such that the resultant diamond layer has a working surface which inversely corresponds to the diamond interface surface configuration of the mold.
- 22. The diamond tool of claim 21, wherein said mold comprises

a metal material.

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- 23. The diamond tool of claim 22, wherein said metal material is a member selected from the group consisting of tungsten, molybdenum, tantalum, zirconium, vanadium, chromium, carbides thereof, copper, and mixtures thereof.
- 24. The diamond tool of claim 21, wherein said diamond interface surface is smooth.
- 25. The diamond tool of claim 21, wherein said diamond interface surface is rough.
- 26. The diamond tool of claim 21, wherein said diamond interface surface has a concave configuration.
 - 27. The diamond tool of claim 21, wherein said diamond interface surface has a convex configuration.
- 28. The diamond tool of claim 21, wherein said diamond interface surface configuration inversely corresponds to the shape of a drawing dye.
 - 29. The diamond tool of claim 28, wherein said drawing dye

has a channel with a non-spherical shape.

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- 30. The diamond tool of claim 21, wherein said diamond interface surface configuration inversely corresponds to the shape of a chemical mechanical polishing (CMP) pad dresser.
- 31. The diamond tool of claim 21, wherein said diamond interface surface configuration inversely corresponds to the shape of a pipe.
 - 32. The diamond tool of claim 21, wherein said diamond interface surface configuration inversely corresponds to the shape of a diaphragm.
 - 33. The diamond tool of claim 21, wherein said diamond interface surface configuration inversely corresponds to the shape of a cutting element.
- 34. The diamond tool of claim 33, wherein said cutting element contains chip breakers.
 - 35. The diamond tool of claim 21, wherein said diamond layer has a thickness of from about 20 microns to about 200

microns.

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- 36. The diamond tool of claim 21, further comprising the step of increasing the thickness of said diamond layer to a desired thickness, using a non-chemical vapor deposition process.
- 37. The diamond tool of claim 21, wherein said CVD technique is a member selected from the group consisting of: hot filament, microwave plasma, oxyacetylene flame, and arc jet techniques.
- 38. The diamond tool of claim 37, wherein said CVD technique utilizes a combination of methane and hydrogen gasses.
- 39. The diamond tool of claim 21, wherein step c) is accomplished by chemically removing the mold from the diamond layer.
- 40. The diamond tool of claim 21, further comprising the step of attaching said diamond layer to a non-diamond material for incorporation into a tool.
 - 41. A diamond tool comprising:
 - a) a diamond layer having working surface with a shape

which inversely corresponds to the configuration of a diamond interface surface in an ephemeral mold, upon which said diamond layer is deposited; and

- b) a non-diamond layer joined to the diamond layer.
- 42. The diamond tool of claim 41, wherein said working surface is smooth.
- 43. The diamond tool of claim 41, wherein said working surface is rough.

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- 44. The diamond tool of claim 41, wherein said working surface has a concave configuration.
- 15 45. The diamond tool of claim 41, wherein said working surface has a convex configuration.
 - 46. The diamond tool of claim 41, wherein said tool is a drawing dye.
 - 47. The diamond tool of claim 46, wherein said drawing dye has a channel with a non-spherical shape.
 - 48. The diamond tool of claim 41, wherein said tool is a

chemical mechanical polishing (CMP) pad dresser.

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- 49. The diamond tool of claim 41, wherein said tool is a pipe water jet nozzle.
- 50. The diamond tool of claim 41, wherein said diamond tool is a diaphragm.
- 51. The diamond tool of claim 41, wherein said tool is a cutting element.
 - 52. The diamond tool of claim 51, wherein said cutting element contains chip breakers.
- 15 53. The diamond tool of claim 41, wherein said diamond layer has a thickness of from about 20 microns to about 200 microns.
 - 54. The diamond tool of claim 41, said diamond layer is comprises both diamond deposited using a CVD technique, and diamond which was not deposited using a CVD technique.
 - 55. The method of claim 1, wherein said diamond interface surface is not subjected to mechanical finishing.

- 56. The method of claim 1, wherein said diamond working surface is essential free of micro cracks.
- 57. The method of claim 1, wherein said diamond interface surface configuration inversely corresponds to the shape of an extruding dye.

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- 58. The method of claim 11, wherein said diamond pipe is a water jet nozzle.
- 59. The method of claim 12, wherein said diamond diaphragm is a tweeter diaphragm.
- 60. The method of claim 13, wherein said cutting element is an insert.
 - 61. The method of claim 21, wherein said diamond interface surface configuration inversely corresponds to the shape of an extruding dye.
 - 62. The method of claim 31, wherein said diamond pipe is a water jet nozzle.
 - 63. The method of claim 32, wherein said diamond diaphragm is

a tweeter diaphragm.

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64. The method of claim 33, wherein said cutting element is an insert.